# Readout of the Mu3e pixel detector

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INTERNATIONAL MAX PLANCK RESEARCH SCHOOL





Search for the charged lepton flavor violating decay  $\mu^+ \rightarrow e^+ e^- e^+$ 



- Stopped muons decay in a solenoidal magnetic field of **B** = 1**T**
- Low momentum electrons  $p_e \leq 53 \text{ MeV/c}$
- Multiple scattering dominates momentum resolution
  - Thin silicon pixel tracking detector



### Data Acquisition Concept

Triggerless DAQ
 Continuous hit information from detector
 Three main DAQ layers

 Front-end FPGAs
 Switching boards
 OPU filter farm









#### Data Acquisition Concept





### Data Acquisition Concept



# Pixel Sensors for Mu3e: MuPix

- High Voltage Monolithic Active
   Pixel Sensors (HV-MAPS)
- Charge collection via drift
- Signal amplification and processing
- Latest prototype: MuPix7
- Integrated readout state machine
- Hit information is transferred
   via serial data link @ 1.25 Gb/s
- Next prototype submitted: MuPix8



- o T26.5: L. Huth Irradiated MuPix7
- HK 18.1: H. Augustin The MuPix8
- 5 T94.8: A. Herkert Mu3e Pixel Tracker





- o Internal state machine
- Hit timestamp + pixel address
- Column-wise readout
- Non-chronological readout







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#### Mart



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# MuPix 7 – Serial Data Transfer

- o 8b10b encoded data
- o LVDS link up to 1.6 Gb/s, operated at 1.25 Gb/s
- Mu3e: Electrical connection between sensor and Front-end FPGA over aluminium interconnects T46.6: J. Kröger, Flexprint Design Studies for Mu3e
- o MuPix8: 3 LVDS links per sensor



#### Front-end FPGA

- O Up to 45 LVDS links per FPGA
   ▲ 15 sensors with 3 links each
- o Data decoding
- o Time sorting of hits
- Packets of hits are sent using optical transceivers towards switching boards



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Stratix "

Optical transceivers MiniPod 12 x 6.25 Gb/s Clockchips

SI5342/45

Temperature ICs

Altera Stratix IV

Optical transceivers

QSFP

4 x 6.25 Gb/s

### **Optical Data Transmission**

- Bit error rate tests
   8b10b encoded counter pattern
- MiniPod:
  - AFBR-811FH1Z / AFBR-812FH1Z
  - 1 m long multi-mode fibre
  - No bit errors observed on all 12 channels
  - **BER**  $\leq 3.5 \cdot 10^{-16}$  @ 95% CL per channel



#### QSFP:

- o Molex 106410-A-02
- 3 m long single mode fibre
- No bit errors observed on 3 of 4 channels
- **BER**  $\leq 1.9 \cdot 10^{-15}$  @ 95% CL per channel
- 1 channel not responsive (soldering issue)

# Summary and Outlook

• Three main layers of the triggerless Mu3e DAQ

- o Time sorting of hit data at the front-end FPGA
- Data merging at the switching boards
- Online event filtering on GPU filter farm
- Front-end FPGA prototype tested
  - Error-free optical data transmission at 6.25 Gb/s per channel
- Next step: Realization of the whole Mu3e readout chain

